



**THE DATASHEET OF  
DMP2540UCB9-7**



### Product Summary (Typ. @ $V_{GS} = -4.5V$ , $T_A = +25^\circ C$ )

$BV_{DSS}$	$R_{DS(ON)}$	$Q_g$	$Q_{gd}$	$I_D$
-25V	33m $\Omega$	4.8nC	1.0nC	-5.2A

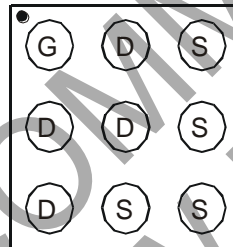
### Features and Benefits

- LD-MOS Technology with the Lowest Figure of Merit:  
 $R_{DS(ON)} = 33m\Omega$  to Minimize On-State Losses  
 $Q_g = 4.8nC$  for Ultra-Fast Switching
- $V_{gs(th)} = -0.6V$  Typ. for a Low Turn-On Potential
- CSP with Footprint 1.5mm x 1.5mm
- Height = 0.62mm for Low Profile
- ESD = 6kV HBM Protection of Gate
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

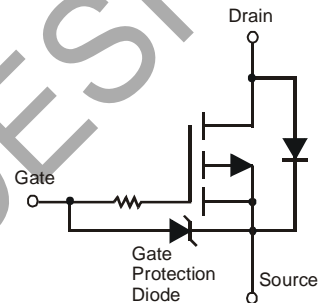
### Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Battery Management
- Load Switch
- Battery Protection



Top-View  
Pin Configuration



Equivalent Circuit

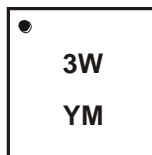
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2540UCB9-7	U-WLB1515-9	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

### Marking Information

U-WLB1515-9



3W = Product Type Marking Code  
YM = Date Code Marking  
Y = Year (ex: F = 2018)  
M = Month (ex: 9 = September)

Date Code Key

Year	2015	2016	2017	2018	2019	2020	2021
Code	C	D	E	F	G	H	I

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	-25	V	
Gate-Source Voltage	V <sub>GSS</sub>	-6	V	
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	Steady State	T <sub>A</sub> = +25°C	-4.0	A
		T <sub>A</sub> = +70°C	-3.0	A
Continuous Drain Current (Note 6) V <sub>GS</sub> = -4.5V	Steady State	T <sub>A</sub> = +25°C	-5.2	A
		T <sub>A</sub> = +70°C	-4.0	A
Pulsed Drain Current (Pulse Duration 10μs, Duty Cycle ≤1%)	I <sub>DM</sub>	-30	A	
Continuous Source Pin Current (Note 6)	I <sub>S</sub>	-2.0	A	
Pulsed Source Pin Current (Pulse Duration 10μs, Duty Cycle ≤1%)	I <sub>SM</sub>	-15	A	
Continuous Gate Clamp Current (Note 5)	I <sub>G</sub>	-0.6	A	
Pulsed Gate Clamp Current (Pulse Duration 10μs, Duty Cycle ≤1%)	I <sub>GM</sub>	-8	A	

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P <sub>D</sub>	1.0	W
Total Power Dissipation (Note 6)	P <sub>D</sub>	1.8	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	126.8	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>θJA</sub>	69	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS (Note 7)</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-25	-	-	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA
Zero Gate Voltage Drain Current @T <sub>C</sub> = +25°C	I <sub>DSS</sub>	-	-	-1	μA	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	-	-	-100	nA	V <sub>GS</sub> = -6V, V <sub>DS</sub> = 0V
<b>ON CHARACTERISTICS (Note 7)</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	-0.4	-0.6	-1.1	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	-	33	40	mΩ	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -2A
			42	50		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -2A
			52	60		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -2A
Forward Transfer Admittance	Y <sub>fs</sub>	-	12	-	S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -2A
Diode Forward Voltage (Note 5)	V <sub>SD</sub>	-	-0.7	-1	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -2A
Reverse Recovery Charge	Q <sub>rr</sub>	-	100	-	nC	V <sub>dd</sub> = -9.5V, I <sub>F</sub> = -2A, di/dt = 200A/μs
Reverse Recovery Time	t <sub>rr</sub>	-	130	-	ns	
<b>DYNAMIC CHARACTERISTICS (Note 8)</b>						
Input Capacitance	C <sub>iss</sub>	-	342	450	pF	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, f = 1.0MHz
Output Capacitance	C <sub>oss</sub>	-	174	225	pF	
Reverse Transfer Capacitance	C <sub>riss</sub>	-	70	90	pF	
Series Gate Resistance	R <sub>G</sub>	-	28	35	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz
Total Gate Charge	Q <sub>g</sub>	-	4.8	6.0	nC	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -10V, I <sub>D</sub> = -2A
Gate-Source Charge	Q <sub>gs</sub>	-	0.5	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>	-	1.0	-	nC	
Turn-On Delay Time	t <sub>D(on)</sub>	-	11	-	ns	V <sub>DD</sub> = -10V, V <sub>GS</sub> = -4.5V, I <sub>DS</sub> = -2A, R <sub>G</sub> = 2Ω
Turn-On Rise Time	t <sub>r</sub>	-	12	-	ns	
Turn-Off Delay Time	t <sub>D(off)</sub>	-	56	-	ns	
Turn-Off Fall Time	t <sub>f</sub>	-	42	-	ns	

- Notes:
5. Device mounted on FR-4 PCB with minimum recommended pad layout.
  6. Device mounted on FR-4 material with 1-inch<sup>2</sup> (6.45-cm<sup>2</sup>), 2-oz. (0.071-mm thick) Cu.
  7. Short duration pulse test used to minimize self-heating effect.
  8. Guaranteed by design. Not subject to production testing.

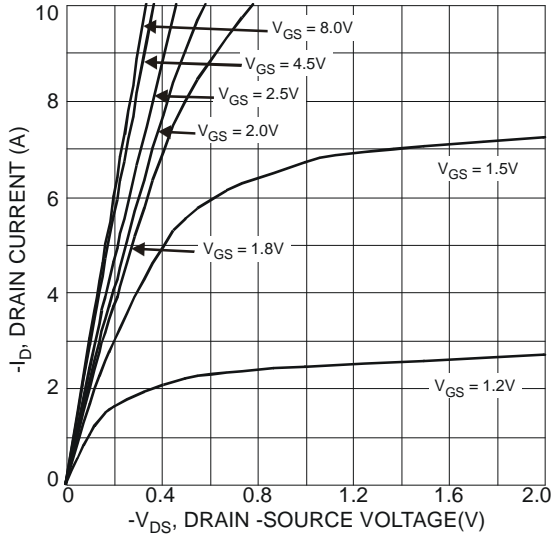


Fig. 1 Typical Output Characteristics

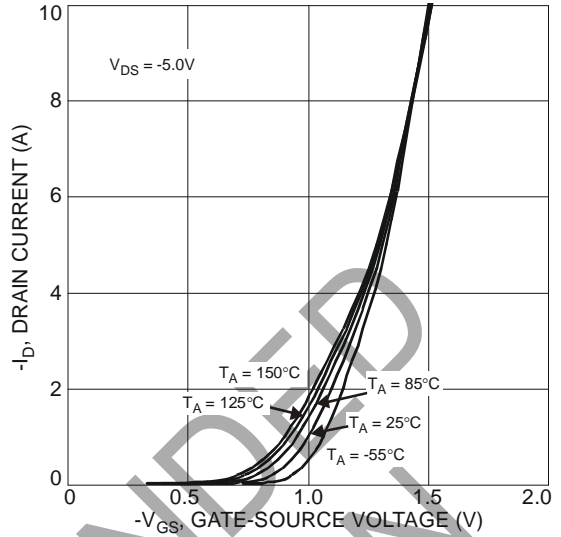


Fig. 2 Typical Transfer Characteristics

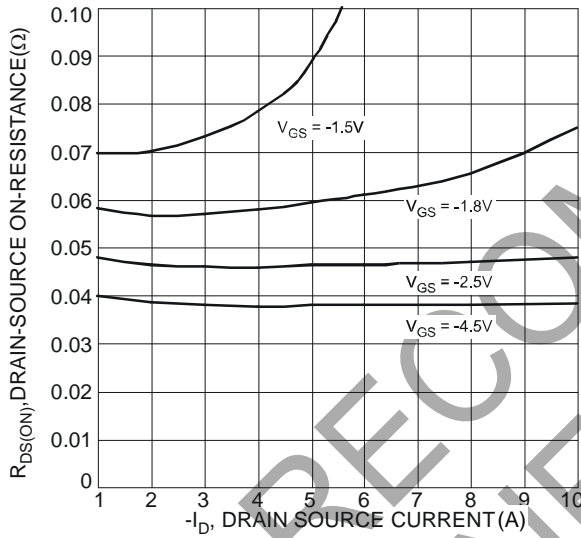


Fig. 3 Typical On-Resistance vs. Drain Current and Gate Voltage

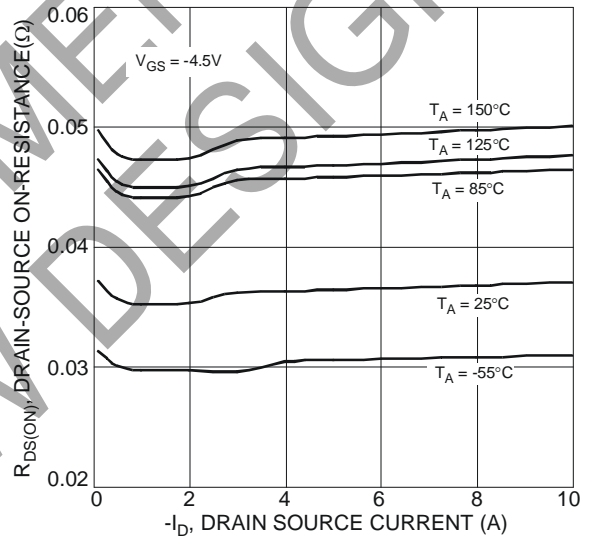


Fig. 4 Typical On-Resistance vs. Drain Current and Temperature

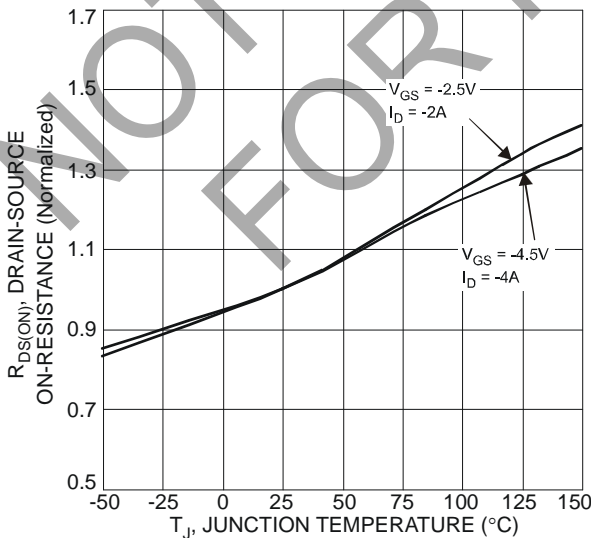


Fig. 5 On-Resistance Variation with Temperature

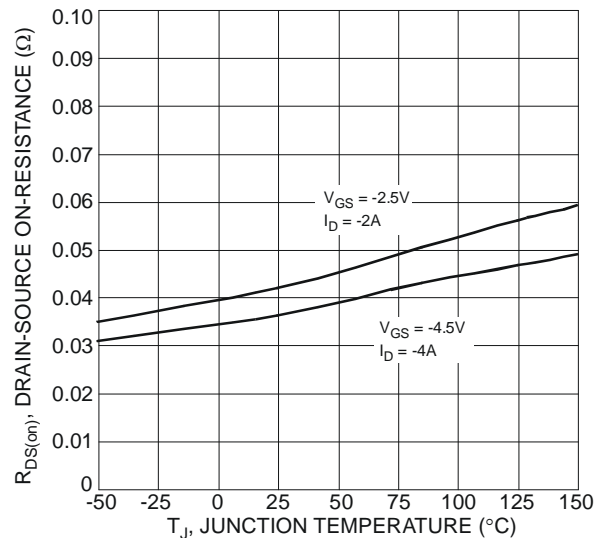


Fig. 6 On-Resistance Variation with Temperature

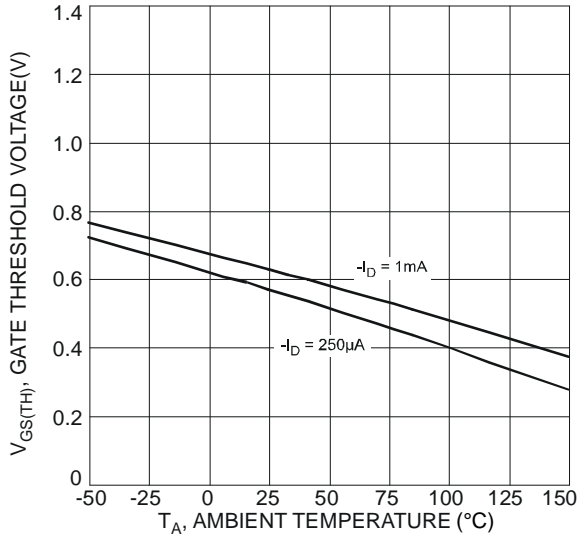


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

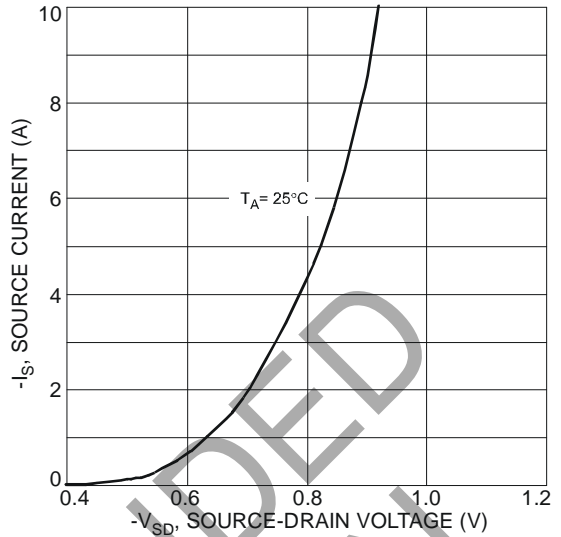


Fig. 8 Diode Forward Voltage vs. Current

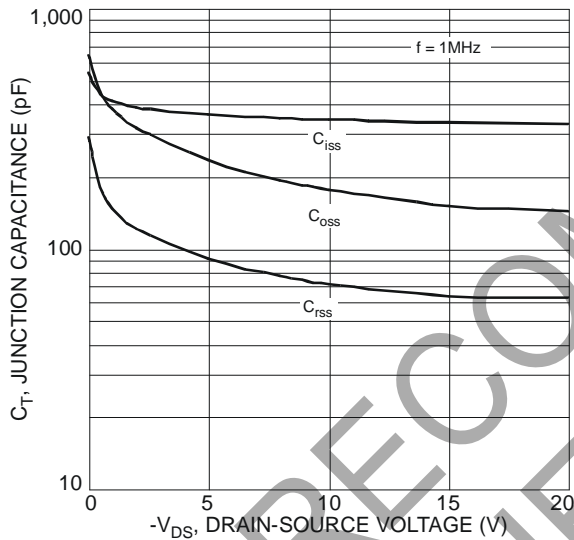


Fig. 9 Typical Junction Capacitance

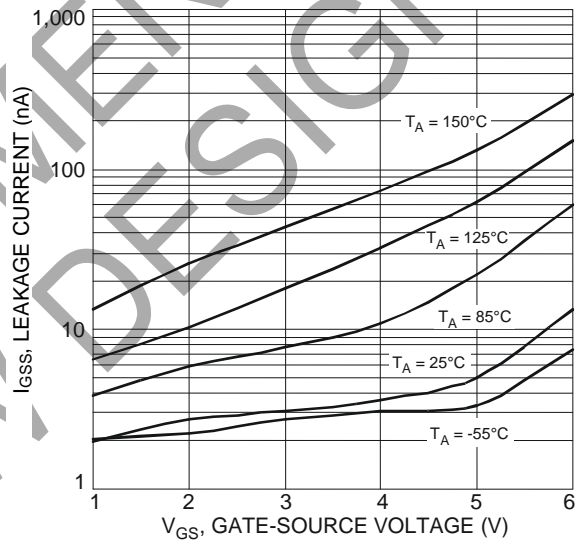


Fig. 10 Gate-Source Leakage Current vs. Voltage

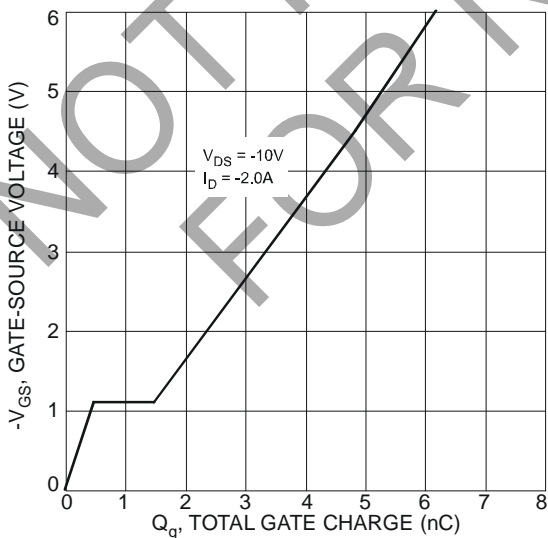


Fig. 11 Gate-Charge Characteristics

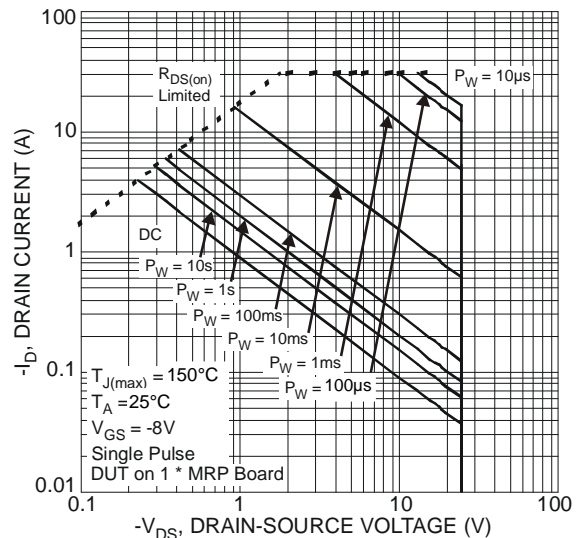
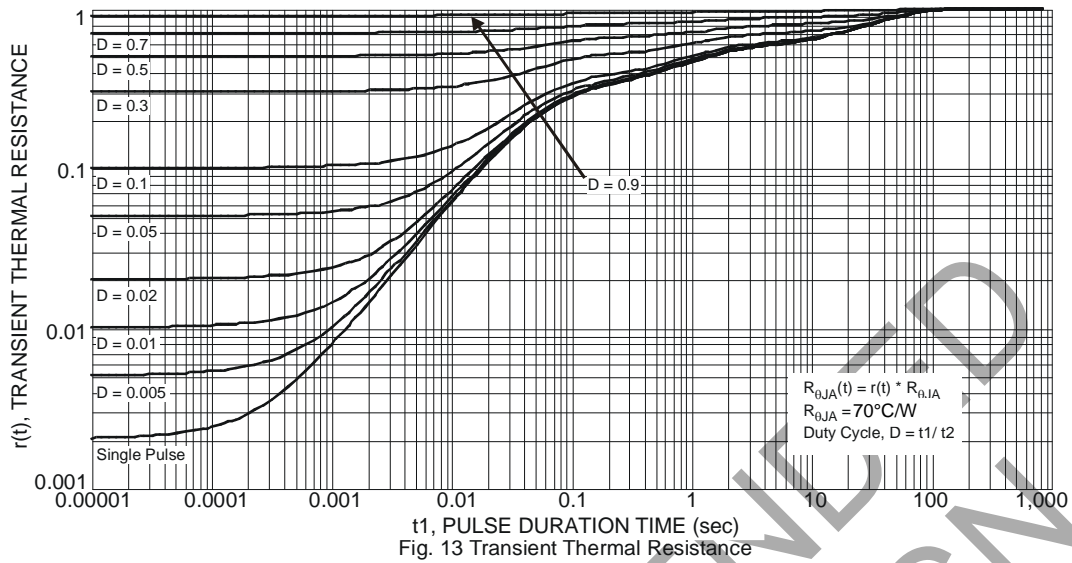
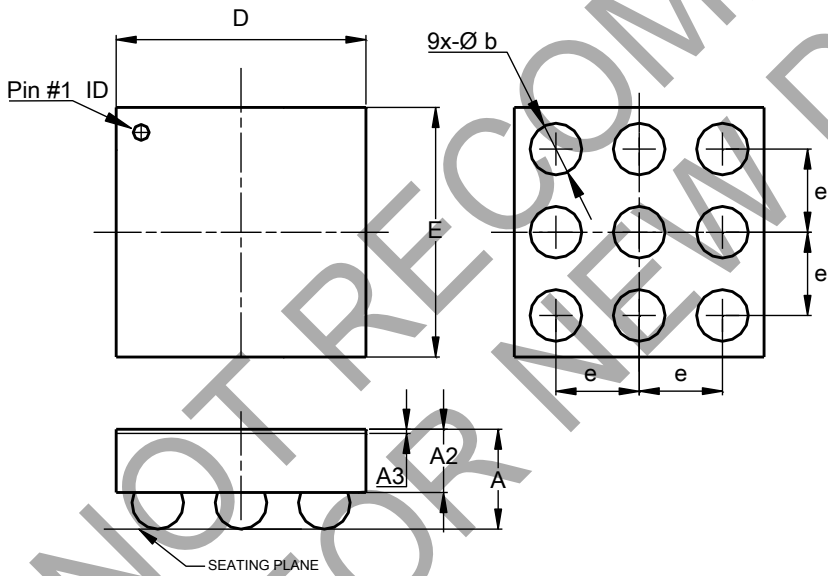


Fig. 12 SOA, Safe Operation Area



**Package Outline Dimensions**

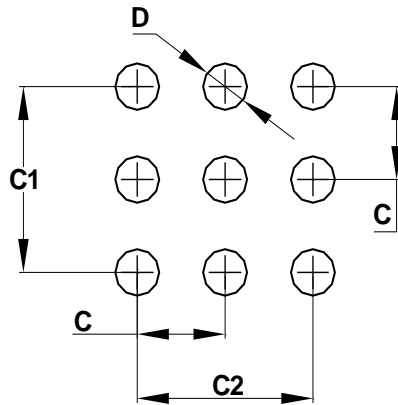
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



U-WLB1515-9			
Dim	Min	Max	Typ
A	--	0.62	--
A2	--	0.36	0.36
A3	0.020	0.030	0.025
b	0.27	0.37	0.32
D	1.47	1.50	1.49
E	1.47	1.50	1.49
e	--	--	0.50
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	0.50
C1	1.00
C2	1.00
D	0.25

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